

#### Dual 2:1 USB2.0 Mux/De-Mux with DC 30V Over-Voltage Protection

### **Descriptions**

The RLCS4000 is a bidirectional low-power dual port, high-speed, USB 2.0 analog switch with integrated protection for USB Type-C™ systems. The device is configured as a dual 2:1 or 1:2 switch. It is optimized for use with the USB 2.0 DP/DM lines in a USB Type-C™ system. The RLCS4000 integrated over-voltage protection on the C0+/- pins can withstand up to DC 30V with automatic shutoff circuitry in order to protect system components behind the switch. GPIO controls of SEL and \_EN are 1.8V logic compatible. The RLCS4000 is available in UQFN 1.4x.18-10L with Pb-free and Halogen-free making it a perfect candidate for mobile and space constrained applications.

#### **Features**

- Supply Range 2.5 V to 5.5 V
- Differential 2:1 or 1:2 Switch/Multiplexer
- ➤ Up to DC 30V Overvoltage Protection (OVP) on C0+/- Ports
- ➤ IEC 64000-4-5 Surge Protection w/o External TVS onto C0+/- Ports: ±30V
- > System Side Clamp Voltage Pulse Less than 9V, Duration Less than 200nS
- Powered Off Protection When VDD = 0 V
- > Low RON of 10 Ω Typical
- Insertion loss: -1dB@200MHz, -2dB@650MHz, -3dB@1GHz
- ➤ Con of 4.8 pF , 1.8-V Compatible Logic Inputs,
- Standard Temperature Range of 0°C to 85°C

#### **Applications**

- Anywhere a USB Type-C™
- Micro-B Connector is Used
- Mobile Phones
- Tablets and Notebooks

#### **Functions and Pin Configuration**

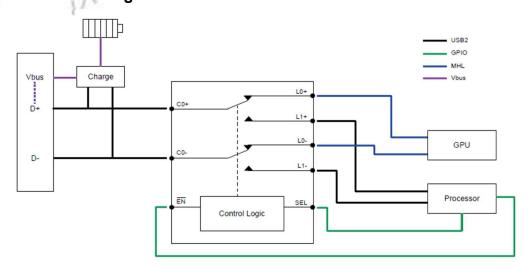
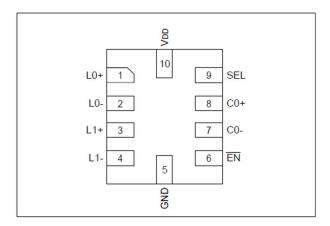


Fig.1 Functional Diagram



# Pin Configuration



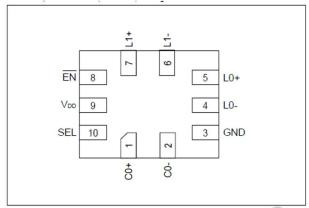


Fig.2 UQFN 1.5x2.0-10L

Fig.3 UQFN 1.4x1.8-10L

## **Pin Descriptions**

UQFN1.6x2.1-10L	UQFN1.4x1.8-10L	Pin Name	Signal Type	Description	
8	1	C0+	I/O	Signal I/O, Common Port	
7	2	C0-	I/O	Signal I/O, Common Port	
3	7	L1+	I/O	Signal I/O, Channle 1	
4	6	L1-[7]	I/O	Signal I/O, Channle 1	
1	5	L0+	1/0	Signal I/O, Channle 0	
2	4	LO-	I/O	Signal I/O, Channle 0	
9	10	SEL	l	Operation Model Select (when SEL=0: C0→L0, when SEL=1: C0→L1)	
6	8	_EN	I	_EN=1, Power Down is Enabled.	
10	9	VDD	PWR	Positive Supply Voltage	
5 -1	3	GND	GND	Power Ground	

**Table-1 Pin Descriptions** 

## **Truth Table**

Function	SEL	_EN
C0+/- to L0+/-	L	L
C0+/- to L1+/-	Н	L
All Switches Hi-Z	Х	L

Table-2 Truth Table

#### **Order Information**

Package		Part Number	Quantity per Reel
UQFN 1.4x1.8 -10L	Tape and Reel	RLCS4000AQN/R6	3,000PCS
UQFN 1.5x2.0 -10L	Tape and Reel	RLCS4000BQN/R6	3,000PCS



**Electrical Characteristics** (Ta=25°C, VDD=3.3V, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
POWER SUPPLY							
Supply Voltage Range	VDD		2.5	3.3	5.5	V	
Supply Current	Icc	_EN =1 disconnection		5	13	uA	
Supply Current		_EN =0 connection		33	60	uA	
SEL/_EN DIGITAL INPUT C	SEL/_EN DIGITAL INPUT CONTOL						
control input logic high	V <sub>IH</sub>		1.6		5.5	V	
control input logic low	V <sub>IL</sub>		-0.1		0.5	V	
Internal pull-down resistor	R <sub>PD</sub>			2		ΜΩ	
SWITCH ON RESISTANCE A	ND OFF LI	EAKAGE			- 5		
On-Resistance	R <sub>ON</sub>	V <sub>IS</sub> = 0V~0.4V I <sub>OUT</sub> =8mA		10	11	Ω	
R <sub>ON</sub> Flatness <sup>(1)</sup>	R <sub>FLAT</sub>	V <sub>IS</sub> = 0V~0.4V I <sub>OUT</sub> =8mA		0.3	0.5	Ω	
R <sub>ON</sub> Matching Between	$\Delta R_{ON}$	V <sub>IS</sub> = 0V~0.4V I <sub>OUT</sub> =8mA		0.1	0.2	Ω	
Channels <sup>(2)</sup>	ΔIYON	VIS- 0 V 0.4 V 1001-0111/1	1	U.I	0.2	32	
OFF Leakage Current	I <sub>LEAK</sub>	V <sub>C0+/-</sub> = 10V V <sub>L1+/-</sub> = V <sub>D2+/-</sub> =0V	01,	31	50	uA	
SWITCH DYNAMICS		(1)	1	112			
On Capacitance	C <sub>ON</sub>	$V_{C0+/-} = 0.2V, f = 1MHz$	18	4		pF	
Off Capacitance	$C_{OFF}$	$V_{C0+/-} = 0.2V, f = 1MHz$	21,	3		pF	
Off Isolation	Off	$f = 250MHz, R_T = 50\Omega, C_L =$	()	-38		dB	
	<u> </u>	0pF					
Crosstalk <sup>(3)</sup>	XTALK	$f = 250MHz, R_T = 50\Omega, C_L =$		-41		dB	
(Channel-to-Channel)	2 TIVLEN	0pF					
-3dB Bandwidth	BW	$R_T=50\Omega$ , $C_L=0$ pF Signal Power	1.0	1.1		GH	
	O. 8	0dBm				Z	
Break-Before-Make	BBM	$V_{L1+/-} = V_{D2+/-} = 0.4V$ , $R_L = 50\Omega$		1.5		uS	
Turn-on Time	t <sub>OFF</sub>	$V_{C0+/-} = 0.4V, R_L=50\Omega$		20		uS	
14 2 1931	1, .	_EN switches from High to Low					
Turn-off Time	t <sub>OFF</sub>	$V_{C0+/-} = 0.4V, R_L=50\Omega$		1.2		uS	
Drama nation Dalay	4	_EN switches from Low to High		200		0	
Propagation Delay	t <sub>PD</sub>	$V_{C0+/-} = 0.4V$ , $R_L = 50\Omega$		200		pS	
OVER VOLTAGE PROTECTION		V Dising Edge	4.0	4.0	<i>-</i>	1/	
OVP Lockout Threshold	V <sub>OVP</sub>	V <sub>C0+/-</sub> Rising Edge	4.6	4.9	5.2	V	
OVP Hysteresis	V <sub>HYS</sub>	V <sub>C0+/-</sub> Falling Edge		200		mV	
Clamp Voltage on L1+/- and V <sub>CLAMP</sub>		10V shorts to C0+/-		6.5	8	V	
D <sub>2+/-</sub>		with $R_L$ =1K $\Omega$ @ L1+/- and $D_{2+/-}$					
OVP Response Time	t <sub>FP</sub>	10V shorts to C0+/-		200	300	nS	
OVD Doggvern: Times	4	with $R_L=1K\Omega$ @ $L1+/-$ and $D_{2+/-}$	20	45	60		
OVP Recovery Time	t <sub>FPR</sub>	V <sub>C0+/-</sub> jumps from 6V to 1V step	30	45	60	uS	

**Table-4 Electrical Characteristics** 



#### Note:

- (1) Flatness is defined as the difference between maximum and minimum value of ON-resistance at the specified analog signal voltage points.
- (2) RON matching between channels is calculated by subtracting the channel with the lowest max Ron value from the channel with the highest max Ron value.
- (3) Crosstalk is inversely proportional to source impedance

## **Typical Performance Curves** (Ta=25°C, VDD=3.0V, CAP=0.1uF, unless otherwise noted)

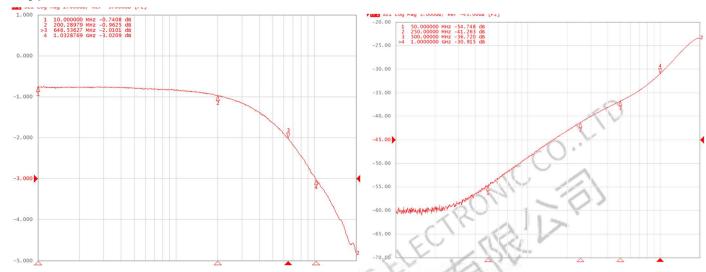
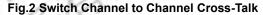


Fig.1 Switch Bandwidth or Insertion Loss



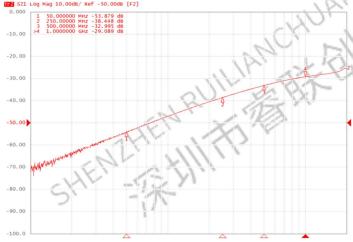
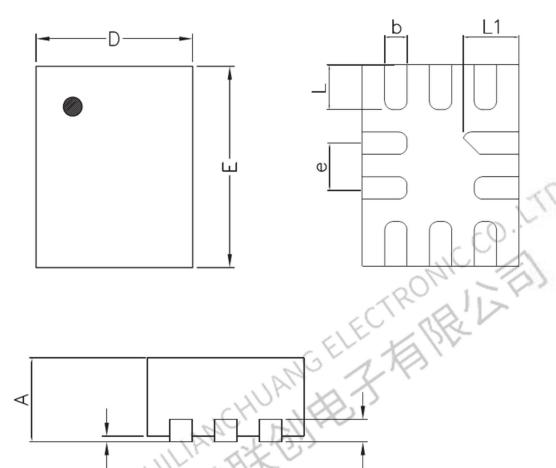


Fig.3 Switch Off Isolation



## **Package Outline Dimensions**

#### UQFN 1.4x1.8 -10L

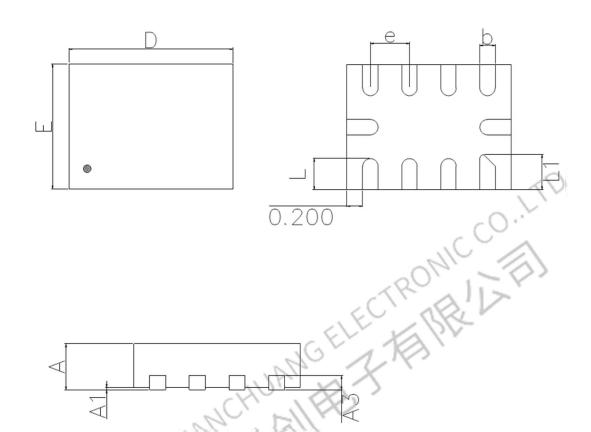


1				
Symbol	Dimension in Millimeters			
	Min.	Max.		
А	0.450	0.550		
A1	0.000	0.050		
A3	0.18	0.152 Ref.		
D	1.350	1.450		
E	1.750	1.850		
b	0.150	0.250		
е	0.400 Typ.			
L	0.350	0.450		
L1	0.450	0.550		



## **Package Outline Dimensions**

#### UQFN 1.5x2.0 -10L



Cumbal	Dimension in Millimeters				
Symbol	Min.	Тур.	Max.		
A	0.500	0.550	0.600		
A1	0.000		0.050		
A3	0.150 Ref.				
D	1.950	2.000	2.050		
E	1.450	1.500	1.550		
b	0.150	0.200	0.250		
е	0.500 (BSC)				
L	0.300	0.350	0.400		
L1	0.350	0.400	0.450		



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